

PATENT ASSIGNMENT

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SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT
CONVEYING PARTY DATA	
Name	Execution Date
Tomonaga NISHIKAWA	10/04/2011
Makoto YOSHIDA	09/30/2011
Tomokazu ITO	10/11/2011
Hiroshi KAMIYAMA	09/30/2011
Takeshi OKUMURA	10/11/2011
Sho NAKAGOMI	09/30/2011
RECEIVING PARTY DATA	
Name:	TDK Corporation
Street Address:	1-13-1, Nihonbashi, Chuo-ku,
City:	Tokyo
State/Country:	JAPAN
Postal Code:	103-8272
PROPERTY NUMBERS Total: 1	
Property Type	Number
Application Number:	13293841
CORRESPONDENCE DATA	
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ATTORNEY DOCKET NUMBER:	074128-0151

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**PATENT
 REEL: 027209 FRAME: 0837**

NAME OF SUBMITTER:

Stephen A. Becker

Total Attachments: 2

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RECORDATION FORM COVER SHEET

Docket No.: 074128-0151

PATENTS ONLY

To the Director of the U. S. Patent and Trademark Office: Please record the attached documents or the new address(es) below.

1. Name of Conveying Party(ies)
Tomonaga NISHIKAWA, Makoto YOSHIDA, Tomokazu ITO, Hiroshi KAMIYAMA, Takeshi OKUMURA, Sho NAKAGOMI

Additional name(s) of conveying party(ies) attached? Yes No

2. Name and address of receiving party(ies)
 Name: **TDK Corporation**

Internal Address:

Address: **1-13-1, Nihonbashi, Chuo-ku, Tokyo 103-8272 JAPAN**

3. Nature of Conveyance/Execution Date(s)

Execution Date(s): **October 4, 2011; September 30, 2011; October 11, 2011; September 30, 2011; October 11, 2011 and September 30, 2011 respectively**

Assignment Merger
 Security Agreement Change of Name
 Joint Research Agreement
 Government Interest Assignment

4. Application or patent number(s):
 A. Patent Application No(s).

5. Name and address to whom correspondence concerning document should be mailed:

This document is being filed together with a new application.
 B. Patent No(s).

6. Total number of applications and patents involved:

Name: **MCDERMOTT WILL & EMERY LLP**
 Internal Address:

Street Address: **600 13th Street, N.W.**

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7. Total fee (37 CFR 1.21(h) & 3.41) \$40.00

Authorized to be charged by credit card
 Authorized to be charged to deposit account
 Enclosed
 None required (government interest not affecting title)

8. Payment Information:

a. Credit Card Last 4 Numbers _____
 Expiration Date _____

b. Deposit Account Number 500417
 Authorized User Name _____

9. Signature.
Stephen A. Becker 26,527  **November 10, 2011**

Name and Registration No. of Person Signing _____ Signature _____ Date _____

Total number of pages including cover sheet, attachments and documents: **2**

ASSIGNMENT

In consideration of the premises and other good and valuable consideration in hand paid, the receipt and sufficiency of which is hereby acknowledged, the undersigned,

- | | |
|-------------------------------|-----------------------------|
| (1) <u>Tomonaga NISHIKAWA</u> | (4) <u>Hiroshi KAMIYAMA</u> |
| (2) <u>Makoto YOSHIDA</u> | (5) <u>Takeshi OKUMURA</u> |
| (3) <u>Tomokazu ITO</u> | (6) <u>Sho NAKAGOMI</u> |

who have made a certain new and useful invention, hereby sell, assign and transfer unto

TDK Corporation, a Japanese Corporation, having a place of business at 1-13-1, Nihonbashi,
Chuo-ku, Tokyo 103-8272, JAPAN

its successors and assigns (hereinafter designated "ASSIGNEE") the entire right, title and interest for the United States of America as defined in 35 U.S.C. 100 in the invention entitled

COIL COMPONENT AND METHOD OF MANUFACTURING THE SAME

(a) for which an application for United States Letters Patent was filed on _____,
and identified by United States Serial No. _____; or

(b) for which an application for United States Letters Patent was executed on _____,

and the undersigned hereby authorize and request the United States Commissioner of Patents and Trademarks to issue any and all United States Letters Patent which may be granted therefor and any and all extensions, divisions, reissues, substitutes, renewals, continuations, or continuations-in-part thereof, and the right to all benefits under the International Convention for the Protection of Industrial Property to the said ASSIGNEE, for its interest as ASSIGNEE, its successors, assigns and legal representatives; the undersigned agree that the attorneys of record in said application shall hereafter act on behalf of said ASSIGNEE;

AND the undersigned hereby agree to transfer a like interest, and to render all necessary assistance in making application for and obtaining original, divisional, reissued or extended Letters Patent of the United States, upon request of the said ASSIGNEE, its successors, assigns and legal representatives, and without further remuneration, in and to any improvements, and applications for patent based thereon, growing out of or related to the said invention; and to execute any papers by the said ASSIGNEE, its successors, assigns and legal representatives, deemed essential to ASSIGNEE's full protection and title in and to the invention hereby transferred.

SIGNED on the dates indicated aside our signatures:

INVENTORS	DATE SIGNED
1) <u>Tomonaga Nishikawa</u> Name: Tomonaga NISHIKAWA	<u>2011. 10. 4</u>
2) <u>Makoto Yoshida</u> Name: Makoto YOSHIDA	<u>2011. 9. 30</u>
3) <u>Tomokazu Ito</u> Name: Tomokazu ITO	<u>2011. 10. 11</u>
4) <u>Hiroshi Kamiyama</u> Name: Hiroshi KAMIYAMA	<u>Sep. 30, 2011</u>
5) <u>Takeshi Okumura</u> Name: Takeshi OKUMURA	<u>2011. 10. 11.</u>
6) <u>Sho Nakagomi</u> Name: Sho NAKAGOMI	<u>2011. 9. 30</u>